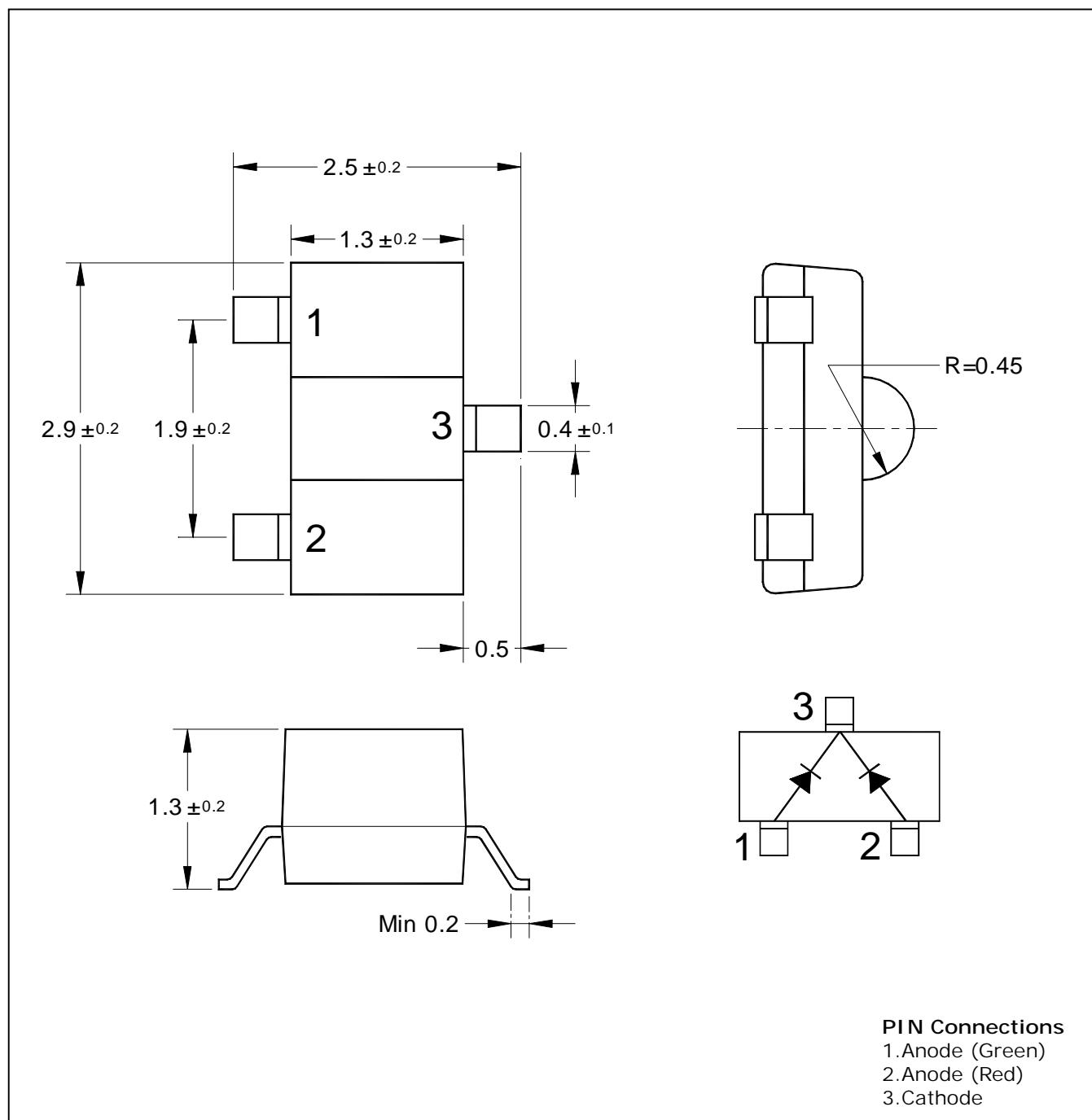


Features

- Compact type
- Radiation size 1.3mm × 2.9mm
- Radiation color (Red, Green)
- Surface mount lead configuration

Outline Dimensions

unit : mm



Absolute maximum ratings

Characteristic	Symbol	Ratings	Unit
Power Dissipation	P _D	55	mW
Forward Current	I _F	30	mA
* ¹ Peak Forward Current	I _{FP}	50	mA
Reverse Voltage	V _R	4	V
Operating Temperature	T _{opr}	-25 85	
Storage Temperature	T _{stg}	-30 100	
* ² Soldering Temperature	T _{sol}	240 for 5 seconds	

*1.Duty ratio = 1/16, Pulse width = 0.1ms

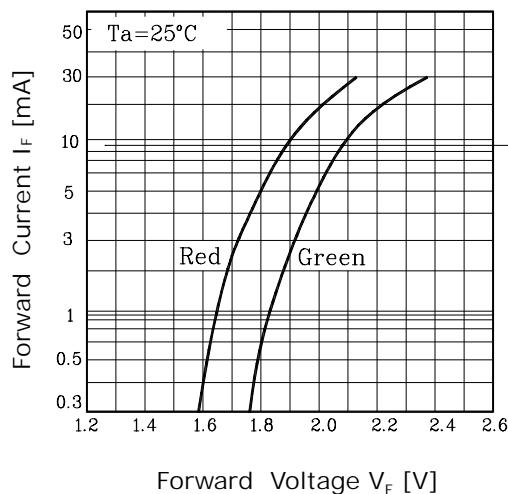
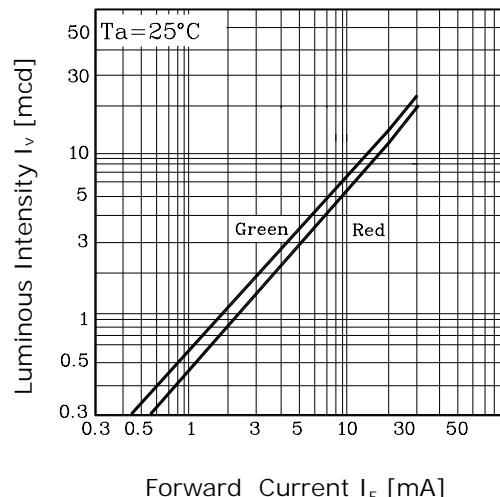
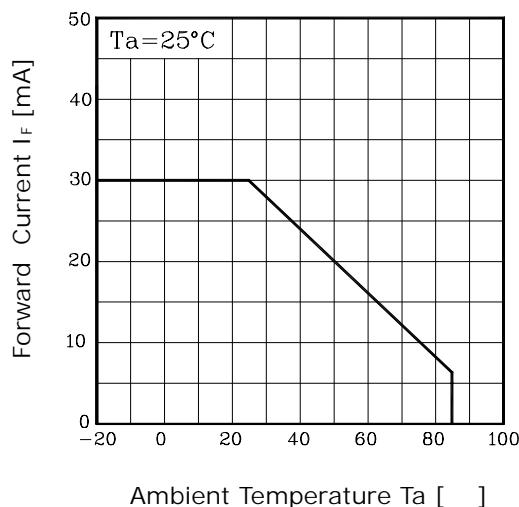
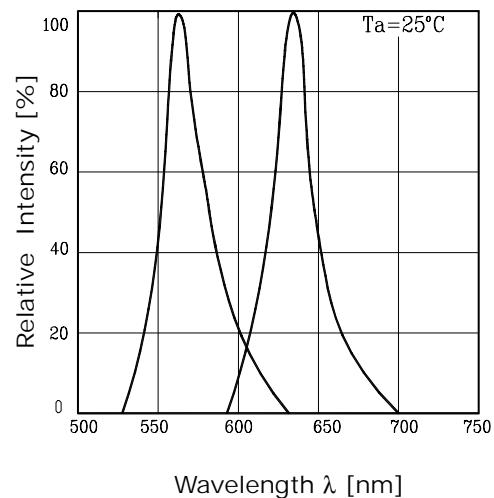
*2.Recommended soldering condition ⇒ Attached

Electrical Characteristics

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V _F	I _F = 20mA	-	2.0	2.7	V
			-	2.1	2.8	
Luminous Intensity	I _V	I _F = 20mA	-	12	-	mcd
			-	15	-	
Peak Wavelength	λ _P	I _F = 20mA	-	630	-	nm
			-	570	-	
Spectrum Bandwidth		I _F = 20mA	-	35	-	nm
			-	30	-	
Reverse Current	I _R	V _R =4V	-	-	10	uA
* ³ Half angle	θ _{1/2}	I _F = 20mA	-	±55	-	deg

*3. θ_{1/2} is the off-axis angle where the luminous intensity is 1/2 the peak intensity

Characteristic Diagrams

Fig. 1 $I_F - V_F$ **Fig. 2 $I_V - I_F$** **Fig. 3 $I_F - T_a$** **Fig. 4 Spectrum Distribution****Fig. 5 Radiation Diagram**